

WHAT IS CLAIMED IS:

1. A display unit comprising:

a support substrate provided with light-emitting devices,

a transparent opposed substrate provided with a black matrix and disposed on the side of the surface formed the light-emitting device of said support substrate, and

a sealing adhesive resin charged between said support substrate and said opposed substrate in the condition of sealing said light-emitting devices.

2. A display unit as set forth in claim 1, wherein said opposed substrate is provided in the condition where the surface formed the black matrix thereof is faced to said support substrate.

3. A display unit as set forth in claim 2, wherein an anti-reflection film is provided on the surface of said opposed substrate on the side opposite to the surface formed the black matrix.

4. A display unit as set forth in claim 1, wherein said black matrix is comprised of a laminate film having a predetermined reflected light attenuation structure or resin material film.

5. A display unit as set forth in claim 1, wherein

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alignment marks used for aligning said light-emitting devices on said support substrate and said black matrix on said opposed substrate into a predetermined condition are provided on the surface formed the light-emitting device of said support substrate and on said opposed substrate.

6. A display unit as set forth in claim 1, wherein said sealing adhesive resin acquires transparency when cured.

7. A method of manufacturing a display unit comprising the steps of:

providing light-emitting devices on a support substrate,

providing a black matrix on a transparent opposed substrate, and

adhering said support substrate and said opposed substrate in the condition where said light-emitting devices are sealed with an adhesive resin and said adhesive resin is charged between said support substrate and said opposed substrate.

8. A method of manufacturing a display unit as set forth in claim 7, wherein said support substrate and said opposed substrate are adhered in the condition where the surface formed the black matrix of said opposed substrate

is faced to the surface formed the light-emitting device of said support substrate.

9. A method of manufacturing a display unit as set forth in claim 7, wherein alignment of said support substrate and said opposed substrate is conducted so that said black matrix is disposed faced to spaces between said light-emitting devices, in the step of adhering said support substrate and said transparent opposed substrate.

10. A method of manufacturing a display unit as set forth in claim 9, wherein said alignment is conducted by disposing alignment marks provided on the surface formed the light-emitting device of said support substrate and alignment marks provided on said opposed substrate into a predetermined condition.

11. A method of manufacturing a display unit as set forth in claim 9, wherein said alignment of said support substrate and said opposed substrate is conducted in the condition where said support substrate and said opposed substrate are adhered to each other through said adhesive resin and before said adhesive resin is cured, and thereafter said adhesive resin is cured.

12. A method of manufacturing a display unit comprising the steps of disposing an opposed substrate on the side of a display region provided on a support

substrate, and adhering said support substrate and said opposed substrate through an adhesive resin, wherein alignment of said support substrate and said opposed substrate is conducted in the condition where said support substrate and said opposed substrate are adhered to each other through said adhesive resin and before said adhesive resin is cured, and thereafter said adhesive resin is cured.

13. A method of manufacturing a display unit as set forth in claim 12, wherein light-emitting devices are formed in said display region, and said adhesive resin is charged between said support substrate and said opposed substrate in the condition of sealing said light-emitting devices.

14. A method of manufacturing a display unit comprising the steps of disposing an opposed substrate faced to a surface of a support substrate on which light-emitting devices are formed, and adhering said support substrate and said opposed substrate in the condition where said light-emitting devices are sealed with an adhesive resin and said adhesive resin is charged between said support substrate and said opposed substrate, wherein alignment of said support substrate and said opposed substrate is conducted so that alignment marks

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provided on said support substrate and alignment marks
provided on said opposed substrate are disposed in a
predetermined condition, in the step of adhering said
support substrate and said opposed substrate.

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